Overlap of conformance options is highlighted: in 3 standards; in 2 standards

<table>
<thead>
<tr>
<th>Energy Management Approach</th>
<th>NSF 426 (Published)</th>
<th>IEEE 1680.1(Published)</th>
<th>UL 110 (DRAFT)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Suppliers (5.5.1)</td>
<td>ISO 50001 self-declared ISO 50001 certified SEP certified</td>
<td>Suppliers (ISO 50001 certified Energy performance improvement, third party verified SEP certified)</td>
<td>Suppliers (ISO 14001 certified + energy ISO 50001 certified Energy performance improvement, third party verified SEP certified)</td>
</tr>
<tr>
<td>Different points earned, depending on type of energy management approach by supplier facility</td>
<td>Yes.</td>
<td>No.</td>
<td>Yes.</td>
</tr>
</tbody>
</table>
|                            | - ISO 50001 self-declared = ½ credit  
- ISO 50001 certified = 1 credit  
- SEP certified = 2 credits | Equal points earned irrespective of the energy management approach pursued, each of which was considered to have a roughly equivalent environmental impact. | - ISO 14001 with energy management = 0.25 credit  
- ISO 50001 certified = 0.5 credit  
- Energy performance improvement = 0.6 credit (project/vendor doc’n)  
= 0.75 credit (third party verified)  
- SEP certified = 1.4 credits (points not final, as most recently drafted) |
|                            | Optional points are awarded as follows:  
1 optional point for 10 supplier facility credits  
2 optional points for 20 supplier facility credits | | Optional points are awarded as follows:  
5 to 25 optional points available; (out of 127 total for the standard) |
| Supplier facility type | Supplier facilities for components in products declared to conform to this standard:  
- printed circuit board  
- printed circuit board assembly  
- integrated circuit  
- memory  
- microprocessors  
- battery  
- power supply  
- fans  
- final assembly | Supplier facilities for components in products declared to conform to this standard:  
- printed circuit board  
- printed circuit board assembly  
- integrated circuit  
- memory  
- microprocessors  
- battery  
- power supply  
- fans  
- final assembly | Any supplier facility, for products declared to conform to this standard. |
|----------------------|---------------------------------------------------------------------------------|---------------------------------------------------------------------------------|---------------------------------------------------------------------------------|
| **# of Supplier Facilities range** | 1 or 2 optional points earned  
10 supplier facility credits = 1 point  
20 supplier facility credits = 2 points  
Points earned depends on the combination of energy management options achieved at each facility, can vary depending on manufacturer focus or supplier capability.  
For 1 point, a minimum of 5 facilities and a maximum of 20.  
For 2 points, a minimum of 10 facilities and a maximum of 40. | 10 supplier facilities among at least 5 suppliers = 1 point  
20 supplier facilities among at least 10 suppliers = for 2 points  
Points earned depends on the combination of energy management options achieved at each facility, can vary depending on manufacturer focus or supplier capability.  
Requires achieving energy management approach for more facilities if the options achieved are worth less credit, and fewer facilities if the options achieved are worth more credit. | 5 to 25 total points earned  
(Note UL110 structure differs from other standards; 127 total points possible currently) |